

# **FFH15S60S**

#### **Features**

- Stealth Recovery, T<sub>rr</sub> = 35 ns (@ I<sub>F</sub> = 15 A)
- Max Forward Voltage, V<sub>F</sub> = 2.6 V (@ T<sub>C</sub> = 25°C)
- 600V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- · RoHS compliant

## **Applications**

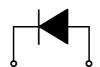
- · General Purpose
- Switching Mode Power Supply
- Boost Diode in Continuous Mode Power Factor
- Power Switching Circuits

# 15 A, 600 V, STEALTH™ II Diode

The FFH15S60S is a STEALTH™ II diode with soft recovery characteristics. It is silicon nitride passivated ion-implanted epitaxial planar construction. This device is intended for use as freewheeling of boost diode in switching power supplies and other power swithching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.







1. Cathode 2. Anode

#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit	
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V	
$V_{RWM}$	Working Peak Reverse Voltage	600	V	
$V_R$	DC Blocking Voltage	600	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 120°C	15	Α	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	150	Α	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-65 to +150	οС	

#### **Thermal Characteristics**

Symbol	Parameter	Ratings	Unit
$R_{\thetaJC}$	Maximum Thermal Resistance, Junction to Case	1.4	°C/W

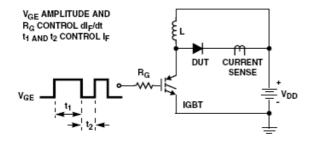
### **Package Marking and Ordering Information**

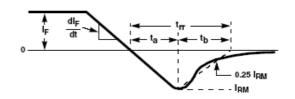
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F15S60S	FFH15S60STU	TO-247-2L	-	-	50

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Unit
V/ 4	I <sub>F</sub> = 15A	T <sub>C</sub> = 25°C	-	2.1	2.6	V
V <sub>F</sub> 1	I <sub>F</sub> = 15A	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.6	-	V
I <sub>R</sub> 1	V <sub>R</sub> = 600V	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	-	100	μА
	$V_{R} = 600V$	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	-	500	
T <sub>rr</sub>	$I_F = 1A$ , di/dt = 100A/ $\mu$ s, $V_R = 30V$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	21	30	ns
T <sub>rr</sub>			-	23	35	ns
I <sub>rr</sub>	$I_F = 15A$ , di/dt = 200A/ $\mu$ s, $V_R = 390V$	$T_C = 25^{\circ}C$	-	2.5	-	Α
S factor	1F = 13A, αναι = 200A/μ3, VR = 390V		-	0.7	-	
Q <sub>rr</sub>			-	29	-	nC
T <sub>rr</sub>			-	55	-	ns
Irr	$I_F = 15A$ , di/dt = 200A/ $\mu$ s, $V_R = 390V$	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	4.3	-	Α
S factor		1 <sub>C</sub> = 125 °C	-	1.1	-	
$Q_{rr}$			-	118	-	nC
$W_{AVL}$	Avalanche Energy ( L = 40mH)		20	-	-	mJ

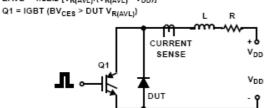
# **Test Circuit and Waveforms**

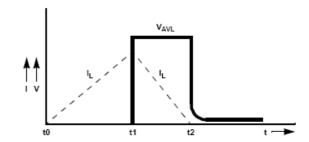




L = 40mH  $R < 0.1\Omega$ 

 $V_{DD} = 50V$  $\mathsf{EAVL} = 1/2\mathsf{LI2} \; [\mathsf{V}_{\mathsf{R}(\mathsf{AVL})}/(\mathsf{V}_{\mathsf{R}(\mathsf{AVL})} \cdot \mathsf{V}_{\mathsf{DD}})]$ 





Notes:
1: Pulse: Test Pulse width = 300μs, Duty Cycle = 2%

# **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop vs. Forward Current

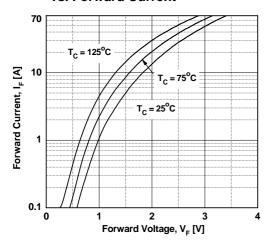


Figure 3. Typical Junction Capacitance

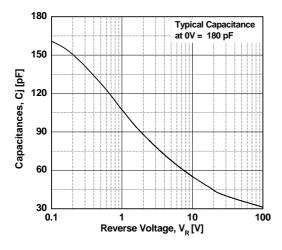


Figure 5. Typical Reverse Recovery Current vs. di/dt

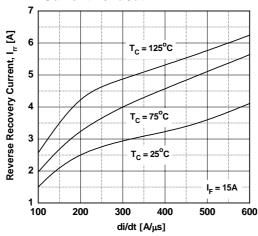


Figure 2. Typical Reverse Current vs. Reverse Voltage

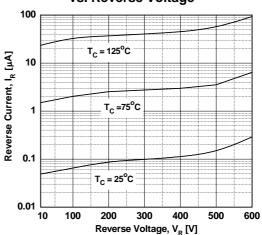
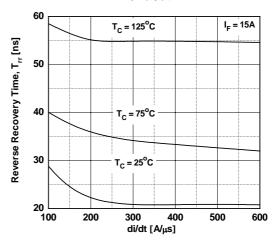
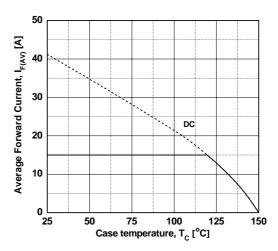


Figure 4. Typical Reverse Recovery Time vs. di/dt

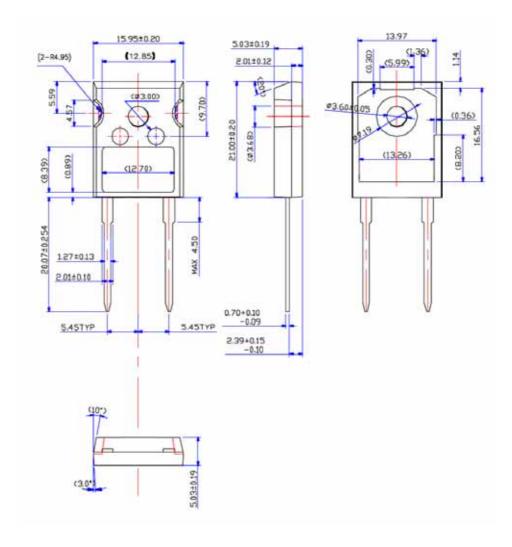


**Figure 6. Forward Current Derating Curve** 



## **Mechanical Dimensions**

# TO-247-2L



Dimensions in Millimeters





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